

**Product data sheet** 

### 1. General description

Dual ultrafast power diode in a SOT78 (TO-220AB) plastic package.

#### 2. Features and benefits

- Soft recovery characteristic
- Low switching loss
- Fast switching
- High thermal cycling performance
- Low thermal resistance
- Low forward voltage drop

### 3. Applications

- Discontinuous Current Mode (DCM) Power Factor Correction (PFC)
- · Output rectifiers in high-frequency switched-mode power supplies

### 4. Quick reference data

Symbol	Parameter	Conditions	Va	lues		Unit
	maximum rating					
V <sub>RRM</sub>	repetitive peak reverse voltage		5	500		V
I <sub>O(AV)</sub>	average output current	SQW; $\delta$ = 0.5; T <sub>mb</sub> ≤ 115 °C; both diodes conducting; <u>Fig. 1</u> ; <u>Fig. 2</u>	20			A
I <sub>FRM</sub>	repetitive peak forward current	SQW; $\delta$ = 0.5 ; t <sub>p</sub> = 25 µs; T <sub>mb</sub> ≤ 115 °C; per diode	20			A
I <sub>FSM</sub>	non-repetitive peak	SIN; $t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; per diode	120			А
	forward current	SIN; $t_p$ = 8.3 ms; $T_{j(init)}$ = 25 °C; per diode	1	32		А
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static ch	aracteristics					
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 10 A; T <sub>j</sub> = 150 °C; <u>Fig. 4</u>	-	0.87	1.05	V
Dynamic	characteristics					
t <sub>rr</sub>	reverse recovery time	I <sub>F</sub> = 1 A; V <sub>R</sub> = 30 V; dI <sub>F</sub> /dt = 100 A/μs; T <sub>i</sub> = 25 °C; <u>Fig. 6</u> ; <u>Fig. 7</u>	-	50	60	ns

# 5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode 1	mb	
2	К	cathode	۲ Y	
3	A2	anode 2		A1 A2 K sym125

# 6. Ordering information

Table 3. Ordering inform	nation				
Type number	Package	•			
	Name	Description	Version		
BYV34-500	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78		

# 7. Marking

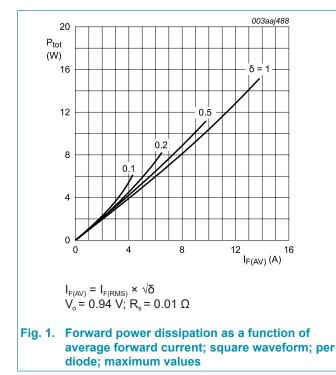
Table 4. Marking codes					
Type number	Marking codes				
BYV34-500	BYV34-500				

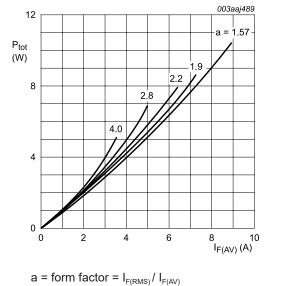
# 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V <sub>RRM</sub>	repetitive peak reverse voltage		500	V
V <sub>RWM</sub>	crest working reverse voltage		500	V
V <sub>R</sub>	reverse voltage	T <sub>mb</sub> ≤ 138 °C; DC	500	V
I <sub>O(AV)</sub>	average output current	SQW; $\delta$ = 0.5; T <sub>mb</sub> ≤ 115 °C; both diodes conducting; Fig. 1; Fig. 2	20	A
I <sub>FRM</sub>	repetitive peak forward current	SQW; $\delta$ = 0.5; t <sub>p</sub> = 25 µs; T <sub>mb</sub> ≤ 115 °C; per diode	20	A
I <sub>FSM</sub>	non-repetitive peak	SIN; $t_p = 10 \text{ ms}$ ; $T_{j(init)} = 25 \text{ °C}$ ; per diode	120	А
	forward current	SIN; $t_p$ = 8.3 ms; $T_{j(init)}$ = 25 °C; per diode	132	А
T <sub>stg</sub>	storage temperature		-40 to 150	°C
Tj	junction temperature		150	°C



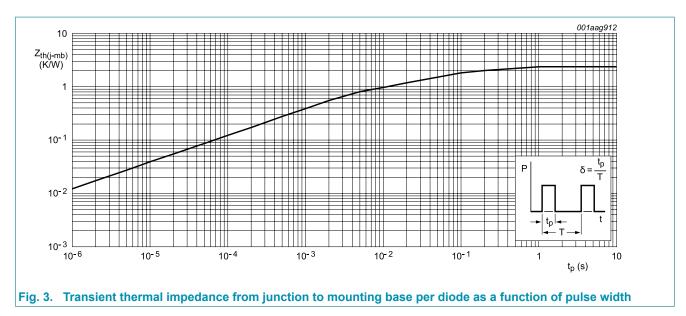


 $a = 10 \text{ m factor} = I_{F(RMS)} / I_{F(AV)}$  $V_o = 0.94 \text{ V}; \text{ R}_s = 0.01 \Omega$ 

Fig. 2. Forward power dissipation as a function of average forward current; sinusoidal waveform; per diode; maximum values

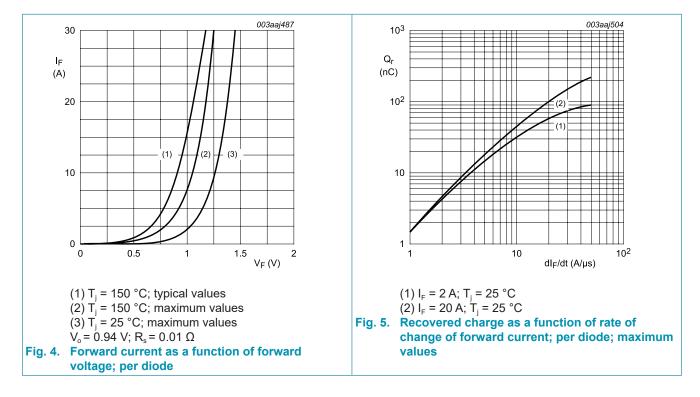
# 9. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base	with heatsink compound; both diodes conducting	-	-	1.6	K/W
		with heatsink compound; per diode; Fig. <u>3</u>	-	-	2.4	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient		-	60	-	K/W



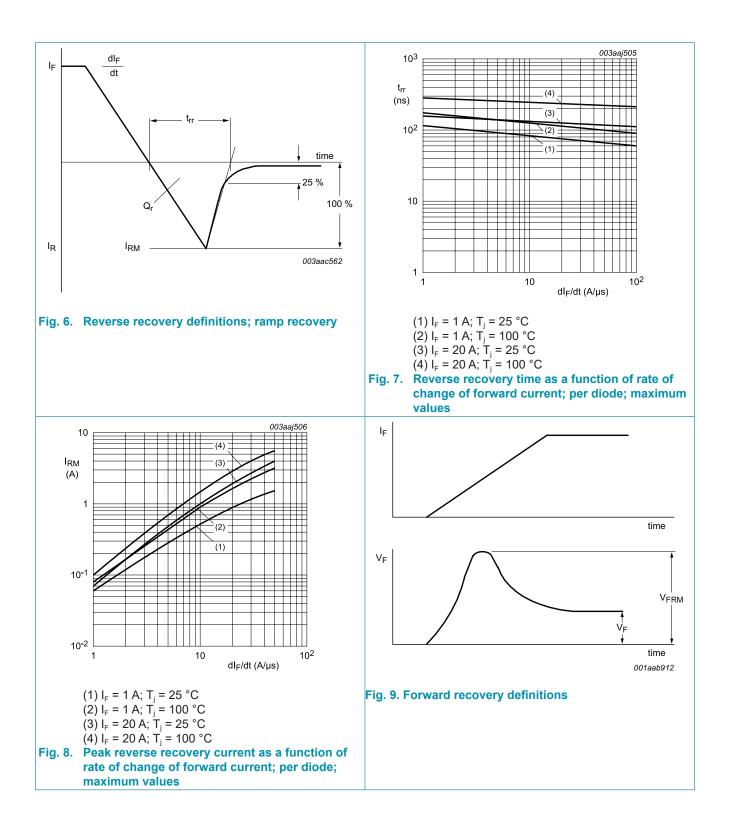
### **10. Characteristics**

Symbol	Parameter	Conditions	N	/lin	Тур	Max	Unit
Static cha	aracteristics						
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 20 A; T <sub>j</sub> = 25 °C; <u>Fig. 4</u>	-		1.1	1.35	V
		I <sub>F</sub> = 10 A; T <sub>j</sub> = 150 °C; <u>Fig. 4</u>	-		0.87	1.05	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 500 V; T <sub>j</sub> = 25 °C	-		10	50	μA
		V <sub>R</sub> = 500 V; T <sub>j</sub> = 100 °C	-		0.2	0.6	mA
Dynamic	characteristics						
Q <sub>r</sub>	recovered charge	$I_F = 2 A; V_R = 30 V; dI_F/dt = 20 A/\mu s;$ Fig. 5; Fig. 6	-		50	50	nC
t <sub>rr</sub>	reverse recovery time	I <sub>F</sub> = 1 A; V <sub>R</sub> = 30 V; dI <sub>F</sub> /dt = 100 A/μs; T <sub>j</sub> = 25 °C; <u>Fig. 6; Fig. 7</u>	-		50	60	ns
I <sub>RM</sub>	peak reverse recovery current	$I_F = 10 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A}/\mu\text{s};$ $T_j = 100 ^\circ\text{C}; \text{ Fig. 6}; \text{ Fig. 8}$	-		4	5	A
V <sub>FRM</sub>	forward recovery voltage	I <sub>F</sub> = 10 A; dI <sub>F</sub> /dt = 100 A/μs; T <sub>j</sub> = 25 °C; Fig. 9	-		2.5	-	V

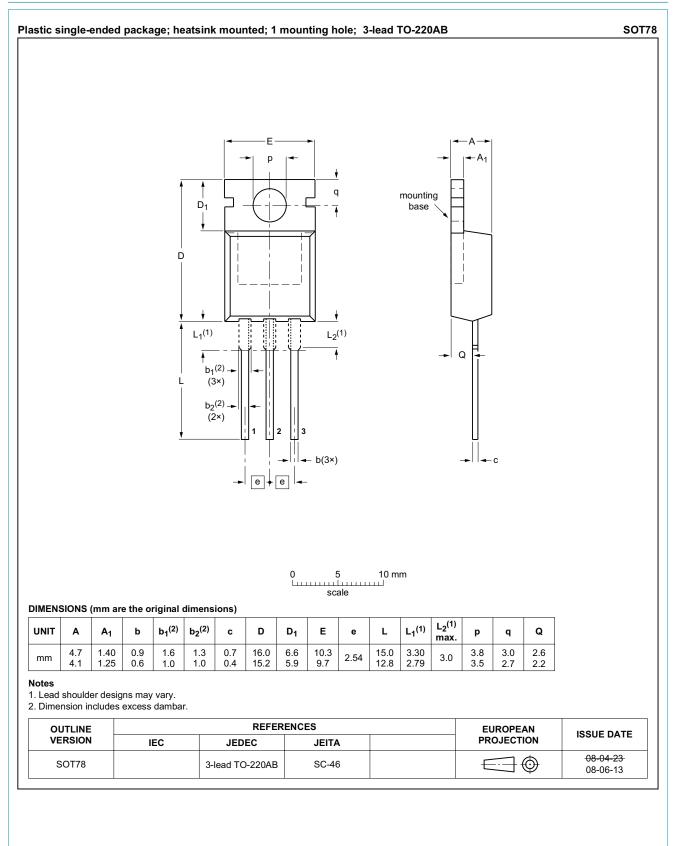


Dual ultrafast power diode

**BYV34-500** 



### **11. Package outline**



# BYV34-500

#### Dual ultrafast power diode

# 12. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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